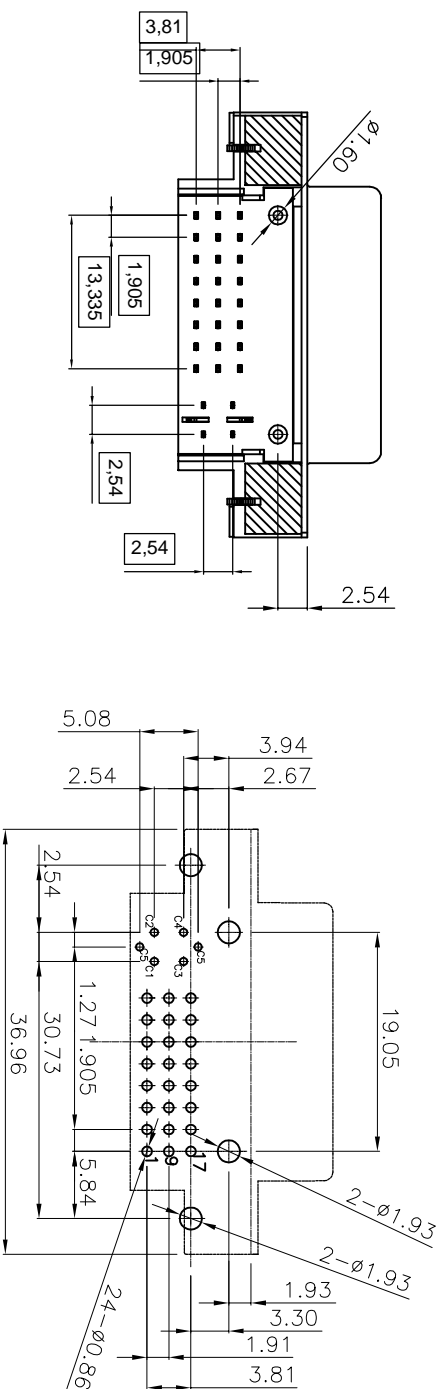


1. HOUSING: THERMOPLASTIC (UL 94V-0).
  2. COVER: THERMOPLASTIC (UL 94V-0).
  3. TERMINAL: COPPER ALLOY,  
GOLD PLATED ON CONTACT AREA,  
TIN PLATED ON SOLDER TAILS,  
NICKEL UNDER PLATED OVERALL.
  4. BOARD LOCK: SPCC, TIN PLATED OVER NICKEL.
  5. SHELL: SPCC, NICKEL PLATED OVERALL.
  6. RIVET: Zn ALLOY, NICKEL PLATED OVERALL.
1. MATING FORCE: 4.5KG/MAX.
  2. UNMATING FORCE: 1.0-4.0KG.
  3. DIELECTRIC WITHSTANDING VOLTAGE:  
500V AC R.M.S. FOR ONE MINUTE.
  4. INSULATION RESISTANCE:  
1000MΩ MIN AT 500V DC.
  5. CONTACT RESISTANCE: 30mΩ MAX.
  6. OPERATING TEMPERATURE : -25°C TO +85°C.



## RECOMMEND PCB LAYOUT

TOLERANCE:  $\pm 0.05$

TOP VIEW

X. $\pm 0.50$	APPD:	TITLE: 29PIN 焊板式 母头+D型铜箔
X. $\pm 0.20$	Mr. wu	
.XX $\pm 0.10$	CHKD: Mr. wu	
.XXX $\pm 0.05$		
X' $\pm 2'$	DR:	PART NO: JT0NS-0038
X' $\pm 1'$	Gas cheng	

A	JIONS-DVI-0011		2011/02/01
REV	ECN NO	DESCRIPTION	DATE

**Jions** 北京玖思启明电子科技有限公司

	<b>UNITS:</b> mm	<b>SCALE:</b> 1:1	<b>DWG NO:</b> www.jions.com.cn	客户图 <b>SHEET: 1 OF 1</b>
<b>REV:</b>				